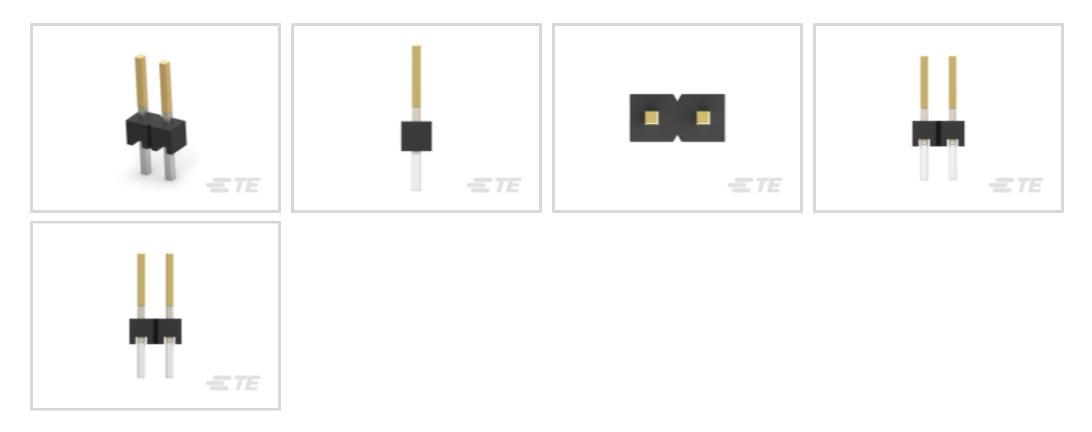


AMPMODU | AMPMODU Headers

TE Internal #: 5-146280-2 PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 1

Features



Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	2
Number of Rows	1
Board-to-Board Configuration	Parallel
Body Features	
Primary Product Color	Black
Contact Features	

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PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Circuit Application ndustry Standards	Signal
Operation/Application	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Housing Temperature Rating	High
Jsage Conditions	
PCB Thickness (Recommended)	1.6 mm[.063 in]
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)
Centerline (Pitch)	2.54 mm[.1 in]
lousing Features	
Connector Mounting Type	Board Mount
PCB Mount Alignment	Without
PCB Mount Retention	Without
Mating Alignment	Without
lechanical Attachment	
Termination Method to PCB	Through Hole - Solder
Termination Post & Tail Length	3.05 mm[.12 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
ermination Features	
Contact Current Rating (Max)	3 A
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material Finish Contact Shape & Form	Matte Square
DCD Canta at Tamain atian Ana a Diatian Matanial Finish	100 – 200 µin
Mating Square Post Dimension	

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Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500
Packaging Method	Carton
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024
	(241)
	Candidate List Declared Against: JUNE 2024 (241)
	Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900
	ppm per homogenous material. Also BFR
	/CFR/PVC Free

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers







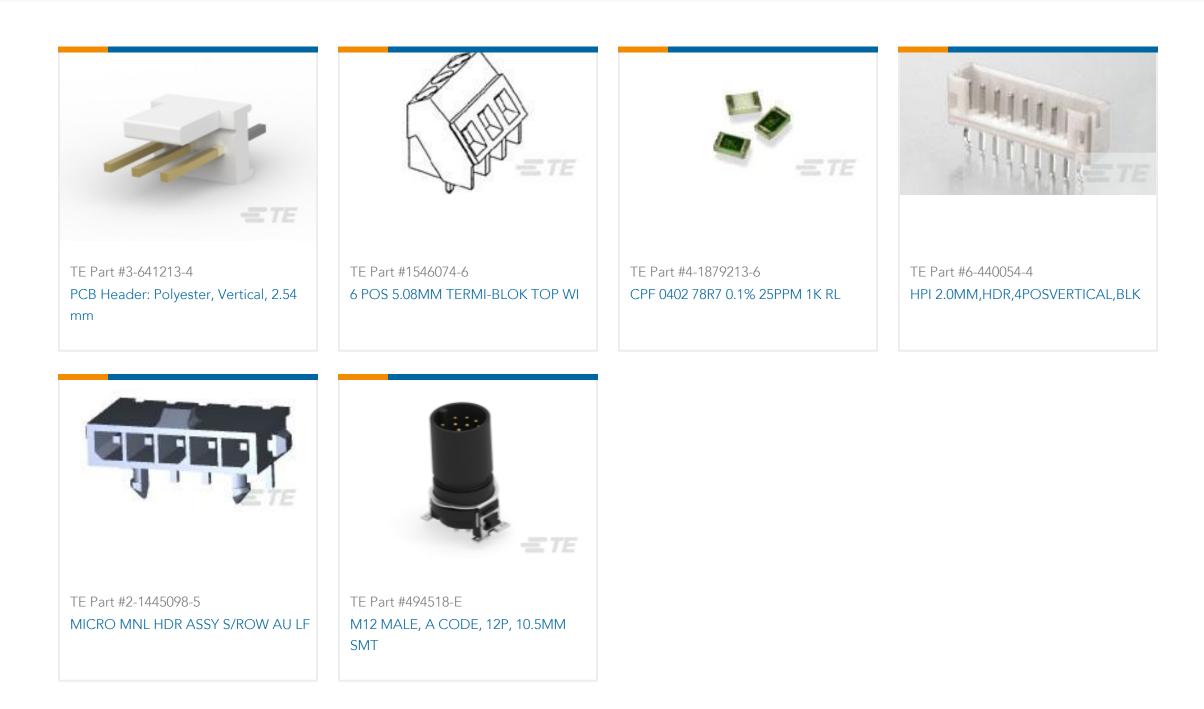
Also in the Series AMPMODU Headers



Customers Also Bought

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers





Documents

Product Drawings 02 MODII HDR SRST B/A .100CL

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_5-146280-2_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-146280-2_D.3d_igs.zip

English

Customer View Model

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ENG_CVM_CVM_5-146280-2_D.3d_stp.zip
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English

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